

BA025

PICRIC ACID (SATURATED, AQUEOUS)

FORMULA

Reagents:

Picric acid	1.18 g
Distilled water	100.00 ml

Directions:

1. Take a loopful of fungi culture on clear, dry glass slide.
2. Mix it with a loopful of picric acid.
3. Tease the fungal culture into thin preparation carefully with the help of wire loop.
4. Place coverslip. Wait for 5 minutes.
5. Observe under high power.

Quality Control:

Appearance: Yellow coloured solution.

Microscopy: Fungal spores and hyphae are stained pale to dark yellow.

Storage: Below 30°C.

Packing : 100 ml

Warning & Precautions :

In Vitro diagnostic Use only. For professional use only. For Laboratory Use. Read the label before opening the container. Wear protective gloves/protective clothing/ eye protection/ face protection. Follow good microbiological lab practices while handling specimens and culture. Standard precautions as per established guidelines should be followed while handling clinical specimens. Safety guidelines may be referred in individual safety data sheets.

Use: Fungal staining

Disposal:

User must ensure safe disposal by autoclaving and/or incineration of used or unusable preparations of this product. Follow established laboratory procedures in disposing of infectious materials and material that comes into contact with clinical sample must be decontaminated and disposed of in accordance with current laboratory techniques.

Disclaimer:

User must ensure suitability of the product(s) in their application prior to use. Products conform solely to the information contained in this and other related BIOMARKLABORATORIES publications.

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